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Features

- Supply Voltage 5V
- Very Low Power Consumption 125 mW
- Very Good Image Rejection By Means of Phase Control Loop for Precise 90° Phase Shifting
- Duty-cycle Regeneration for Single-ended LO Input Signal
- Low LO Input Level -10 dBm
- LO Frequency from 70 MHz to 1 GHz
- Power-down Mode
- 25 dB Gain Control
- Very Low I/Q Output DC Offset Voltage Typically < 5 mV

Benefits

- Low Current Consumption
- Easy to Implement
- Perfect Performance for Large Variety of Wireless Applications

Electrostatic sensitive device. Observe precautions for handling.



1. Description

The silicon monolithic integrated circuit U2794B is a quadrature demodulator manufactured using Atmel's advanced UHF technology. This demodulator features a frequency range from 70 MHz to 1000 MHz, low current consumption, selectable gain, power-down mode and adjustment-free handling. The IC is suitable for direct conversion and image rejection applications in digital radio systems up to 1 GHz such as cellular radios, cordless telephones, cable TV and satellite TV systems.



1000-MHz Quadrature Demodulator

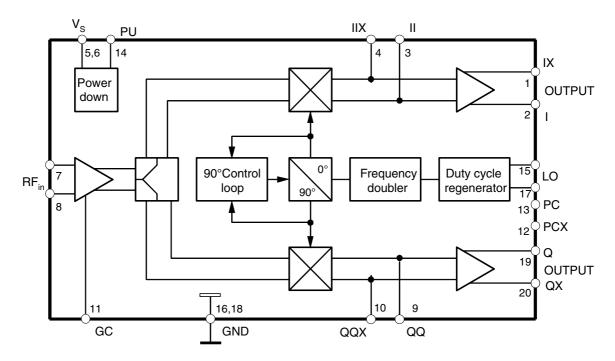
U2794B

Rev. 4653D-CELL-11/05



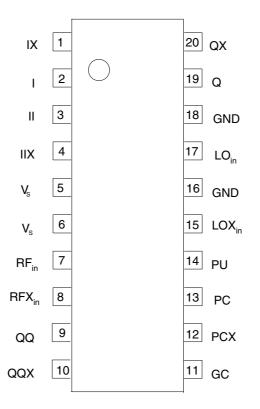


Figure 1-1. Block Diagram



2. Pin Configuration

Figure 2-1. Pinning SSO20



U2794B

| Table 2-1. | Pin Description | | |
|------------|-------------------|----------------------|--|
| Pin | Symbol | Function | |
| 1 | IX | IX output | |
| 2 | I | I output | |
| 3 | II | II lowpass filter I | |
| 4 | IIX | IIX lowpass filter I | |
| 5 | V _S | Supply voltage | |
| 6 | Vs | Supply voltage | |
| 7 | RF _{in} | RF input | |
| 8 | RFX _{in} | RFX input | |
| 9 | QQ | QQ lowpass filter Q | |
| 10 | QQX | QQX lowpass filter Q | |
| 11 | GC | GC gain control | |
| 12 | PCX | PCX phase control | |
| 13 | PC | PC phase control | |
| 14 | PU | PU power up | |
| 15 | LOX _{in} | LOX input | |
| 16 | GND | Ground | |
| 17 | LO _{in} | LO input | |
| 18 | GND | Ground | |
| 19 | Q | Q output | |
| 20 | QX | QX output | |





3. Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

| Parameters | Symbol | Value | Unit |
|---------------------------|------------------|---------------------|------|
| Supply voltage | V _S | 6 | V |
| Input voltage | V _i | 0 to V _S | V |
| Junction temperature | Tj | +125 | °C |
| Storage-temperature range | T _{stg} | -40 to +125 | °C |

4. Thermal Resistance

| Parameters | Symbol | Value | Unit |
|------------------------|-------------------|-------|------|
| Junction ambient SSO20 | R _{thJA} | 140 | K/W |

5. Operating Range

| Parameters | Symbol | Value | Unit |
|---------------------------|------------------|--------------|------|
| Supply-voltage range | V _S | 4.75 to 5.25 | V |
| Ambient-temperature range | T _{amb} | -40 to +85 | °C |

6. Electrical Characteristics

Test conditions (unless otherwise specified); V_S = 5V, T_{amb} = 25°C, referred to test circuit System impedance Z_O = 50 Ω , f_{iLO} = 950 MHz, P_{iLO} = -10 dBm

| No. | Parameters | Test Conditions | Pin | Symbol | Min. | Тур. | Max. | Unit | Type* |
|-----|---------------------------------------|---|------------|--|------|------------|------|----------|--------|
| 1.1 | Supply-voltage range | | 5, 6 | V _S | 4.75 | | 5.25 | V | Α |
| 1.2 | Supply current | | 5, 6 | ا _S | 22 | 30 | 35 | mA | Α |
| 2 | Power-down Mode | I | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| 2.1 | "OFF" mode supply current | $V_{PU} \le 0.5V$ $V_{PU} = 1.0 V^{(1)}$ | 14, 5 6 | I _{SPU} | | ≤ 1 20 | | μΑ μΑ | B D |
| 3 | Switch Voltage | | | | | | | | |
| 3.1 | "Power ON" | | 14 | V _{PON} | 4 | | | V | D |
| 3.2 | "Power DOWN" | | 14 | V _{POFF} | | | 1 | V | D |
| 4 | LO Input, LO _{in} | | | | | | | | |
| 4.1 | Frequency range | | 17 | f _{iLO} | 70 | | 1000 | MHz | D |
| 4.2 | Input level | (2) | 17 | P _{iLO} | -12 | -10 | -5 | dBm | D |
| 4.3 | Input impedance | See Figure 6-10 | 17 | Z _{iLO} | | 50 | | Ω | D |
| 4.4 | Voltage standing wave ratio | See Figure 6-3 | 17 | VSWR _{LO} | | 1.2 | 2 | | D |
| 4.5 | Duty-cycle range | | 17 | DCR _{LO} | 0.4 | | 0.6 | | D |
| 5 | RF Input, RF _{in} | | | | | | | | |
| 5.1 | Noise figure (DSB) symmetrical output | at 950 MHz ⁽³⁾ at 100 MHz | 7, 8 | NF | | 12 10 | | dB | D |
| 5.2 | Frequency range | $f_{iRF} = f_{iLO} \pm BW_{YQ}$ | 7, 8 | f _{iRF} | 40 | | 1030 | MHz | D |
| 5.3 | -1 dB input compression point | High gain Low gain | 7, 8 | P _{1dBHG} P _{1dBLG} | | 8 +3.5 | | dBm | D |
| 5.4 | Second order IIP | (4) | 7, 8 | IIP _{2HG} | | 35 | | dBm | D |
| 5.5 | Third order IIP | High gain Low gain | 7, 8 | IIP _{3HG} IIP _{3LG} | | +3 +13 | | dBm | D |
| 5.6 | LO leakage | Symmetric input Asymmetric input | 7, 8 | L _{OL} | | ≤60 ≤55 | | dBm | D |
| 5.7 | Input impedance | see Figure 6-10 | 7, 8 | Z _{iRF} | | 500110.8 | | ΩllpF | D |

*) Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Notes: 1. During power-down status a load circuitry with DC-isolation to GND is assumed, otherwise a current of I \approx (VS –0.8V)/RI has to be added to the above power-down current for each output I, IX, Q, QX.

- 2. The required LO-Level is a function of the LO frequency (see Figure 6-6).
- 3. Measured with input matching. For 950 MHz, the optional transmission line T3 at the RF input may be used for this purpose. Noise figure measurements without using the differential output signal result in a worse noise figure.
- 4. Using pins 7 and 8 as a symmetric RF input, the second-order IIP can be improved.
- 5. Due to test board parasitics, this bandwidth may be reduced and not be equal for I, IX, Q, QX. If symmetry and full bandwidth is required, the lowpass pins 3, 4 and 9, 10 should be isolated from the board. the bandwidth of the I/Q outputs can be increased further by using a resistor between pins 3, 4, 9 and 10. These resistors shunt the internal loads of RI ~ 5.4 kΩ The decrease in gain here has to be considered.
- 6. The internal current of the output emitter followers is 0.6 mA. This reduces the undistorted output voltage swing at a 50 Ω load to approximately 30 mV. For low signal distortion the load impedance should be RI \geq 5 k Ω .
- 7. Referred to the level of the output vector $\sqrt{I^2 + Q^2}$
- 8. The low-gain status is achieved with an open or high-ohmic pin 11. A recommended application circuit for switching between high and low gain status is shown in Figure 6-1.





6. Electrical Characteristics (Continued)

Test conditions (unless otherwise specified); V_S = 5V, T_{amb} = 25°C, referred to test circuit System impedance Z_O = 50 Ω , f_{iLO} = 950 MHz, P_{iLO} = -10 dBm

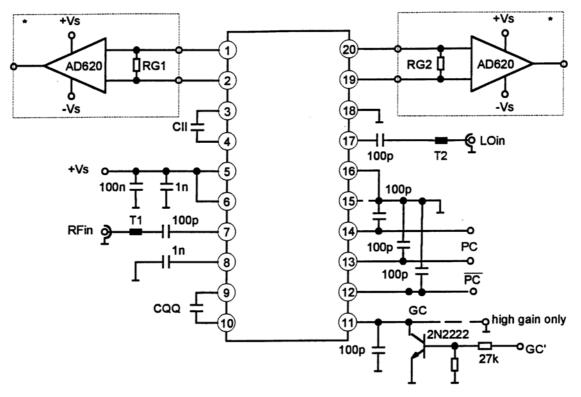
| No. | Parameters | Test Conditions | Pin | Symbol | Min. | Тур. | Max. | Unit | Type* |
|-----|--|-----------------------------------|-----------------|---|------|----------------|------|------------------|---------------|
| 6 | I/Q Outputs (I, IX, Q, | QX) Emitter Follower | l = 0.6 mA | | | | | | |
| 6.1 | 3-dB bandwidth w/o external C | | 1, 2, 19, 20 | BWI/Q | ≥ 30 | | | MHz | D |
| 6.2 | I/Q amplitude error | | 1, 2, 19, 20 | Ae | -0.5 | ≤±0.2 | +0.5 | dB | В |
| 6.3 | I/Q phase error | | 1, 2, 19, 20 | Pe | -3 | ≤ ±1.5 | +3 | Deg | В |
| 6.4 | I/Q maximum output swing | Symm. output $R_L > 5 k\Omega$ | 1, 2, 19, 20 | V _{PP} | | | 2 | | D |
| 6.5 | DC output voltage | | 1, 2, 19, 20 | V _{OUT} | 2.5 | 2.8 | 3.1 | V | Α |
| 6.6 | DC output offset voltage | (6) | 1, 2, 19, 20 | V _{offset} | | < 5 | | mV | Test spec. |
| 6.7 | Output impedance | see Figure 6-10 | 1, 2, 19, 20 | Z _{out} | | 50 | | Ω | D |
| 7 | Gain Control, GC | | • | | | | | | <u>.</u> |
| 7.1 | Control range power Gain high Gain low | (7) | 11 | GCR G _H G _L | | 25 23 –2 | | dB dBm dBm | D B D |
| 7.2 | Switch Voltage | | • | | | | | | |
| 7.3 | "Gain high" | | 11 | | | | 1 | V | |
| 7.4 | "Gain low" | (8) | 11 < open | | | | | | |
| 7.5 | Settling Time, ST | | | | | | | | |
| 7.6 | Power "OFF" - "ON" | | | T _{SON} | | < 4 | | μs | D |
| 7.7 | Power "ON" - "OFF" | | | T _{SOFF} | | < 4 | | μs | D |

*) Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Notes: 1. During power-down status a load circuitry with DC-isolation to GND is assumed, otherwise a current of I ≈ (VS –0.8V)/RI has to be added to the above power-down current for each output I, IX, Q, QX.

- 2. The required LO-Level is a function of the LO frequency (see Figure 6-6).
- 3. Measured with input matching. For 950 MHz, the optional transmission line T3 at the RF input may be used for this purpose. Noise figure measurements without using the differential output signal result in a worse noise figure.
- 4. Using pins 7 and 8 as a symmetric RF input, the second-order IIP can be improved.
- 5. Due to test board parasitics, this bandwidth may be reduced and not be equal for I, IX, Q, QX. If symmetry and full bandwidth is required, the lowpass pins 3, 4 and 9, 10 should be isolated from the board. the bandwidth of the I/Q outputs can be increased further by using a resistor between pins 3, 4, 9 and 10. These resistors shunt the internal loads of RI ~ 5.4 kΩ The decrease in gain here has to be considered.
- 6. The internal current of the output emitter followers is 0.6 mA. This reduces the undistorted output voltage swing at a 50 Ω load to approximately 30 mV. For low signal distortion the load impedance should be RI \geq 5 k Ω
- 7. Referred to the level of the output vector $\sqrt{l^2 + Q^2}$
- 8. The low-gain status is achieved with an open or high-ohmic pin 11. A recommended application circuit for switching between high and low gain status is shown in Figure 6-1.

Figure 6-1. Test Circuit



* optional for single-ended tests (notice 3 dB bandwidth of AD620)

T1, T2 = transmission line Z_{O} = 50 $\!\Omega$

If no GC function is required, connect Pin 11 to GND.

For high and low gain status GC' is to be switched to GND respectively to V_S .

Figure 6-2. I and Q phase for $f_{RF} > f_{LO}$. For $f_{RF} < f_{LO}$ the phase is inverted.

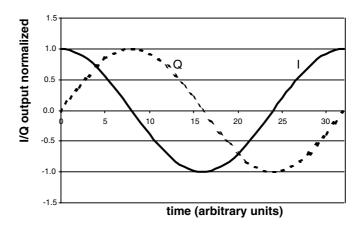






Figure 6-3. Typical VSWR Frequency Response of the LO Input

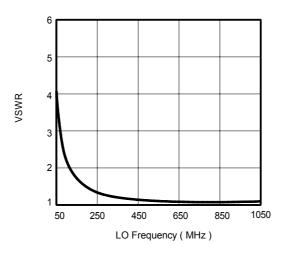


Figure 6-4. Noise Figure versus LO Frequency; o: Value at 950 MHz with RF Input Matching with T3

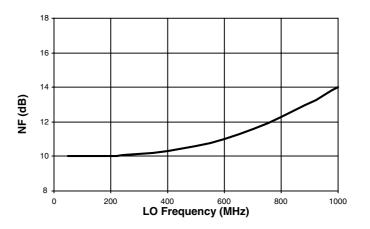
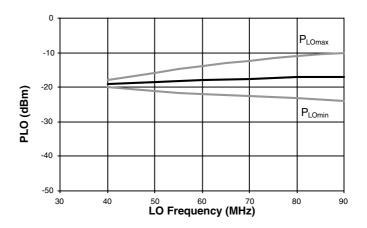


Figure 6-5. Typical Suitable LO Power Range versus Frequency



U2794B

Figure 6-6. Gain versus LO Frequency; x: Value at 950 MHz with RF Input Matching with T3

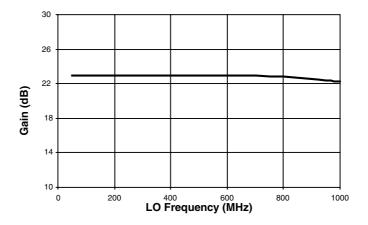


Figure 6-7. Typical Output Signal versus LO Frequency for $P_{RF} = -15$ dBm and PLO = -15 dBm

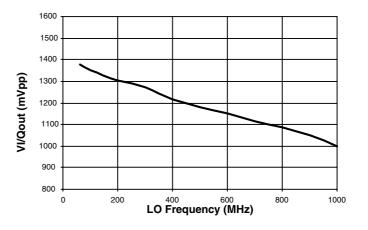


Figure 6-8. Typical Suitable LO Power Range versus Frequency

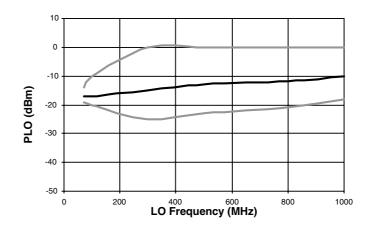






Figure 6-9. Typical Output Voltage (single ended) versus P_{RF} at $T_{amb} = 25^{\circ}C$ and PLO = -15 dBm

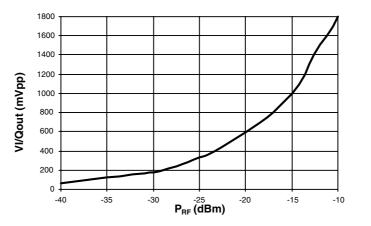
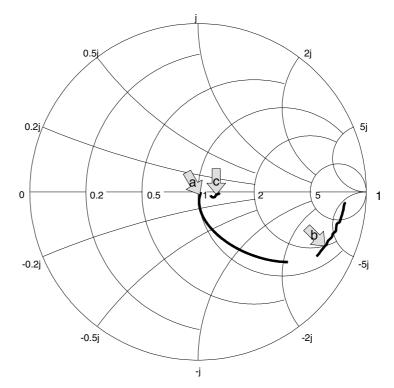


Figure 6-10. Typical S11 Frequency Response



a: LO input, LO frequency from 100 MHz to 1100 MHz, marker: 950 MHz b: RF input, RF frequency from 100 MHz to 1100 MHz, marker: 950 MHz c: I/Q Outputs, Baseband Frequency from 5 MHz to 55 MHz, marker: 25 MHz

Figure 6-11. Evaluation Board Layout

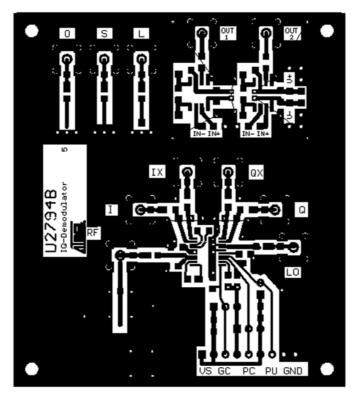
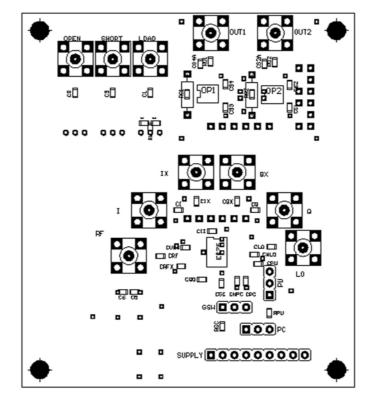


Figure 6-12. Evaluation Board







6.1 External Components

| CUCC | 100 nF | |
|----------|--------|--|
| CRFX | 1 nF | |
| CLO | 100 pF | |
| CNLO | 1 nF | |
| CRF | 100 pF | |
| CII, CQQ | | optional external lowpass filters |
| ТЗ | | transmission line for RF-input matching, to connect optionally |
| CI, CIX | | optional for AC-coupling at |
| CQ, CQX | | baseband outputs |
| CPDN | 100 pF | not connected |
| CGC | 100 pF | |
| CPC | 100 pF | not connected |
| CNPC | 100 pF | not connected |
| GSW | | gain switch |
| | | |

6.2 Calibration Part

| CO, CS, CL | 100 pF |
|------------|--------|
| RL | 50Ω |

6.3 Conversion to Single Ended Output

(see datasheet of AD620)

| OP1, OP2 | | AD620 |
|----------|--------|---|
| RG1, RG2 | | prog. gain, see datasheet, for 5.6 k Ω a gain of 1 at 50 Ω is achieved together with RD1 and RD2. |
| RD1, RD2 | 450Ω | |
| CS1, CS2 | 100 nF | |
| CS3, CS4 | 100 nF | |

U2794B

7. Description of the Evaluation Board

Board material: epoxy; $\varepsilon r = 4.8$, thickness = 0.5 mm, transmission lines: $Z_{\Omega} = 50\Omega$

The board offers the following functions:

- Test circuit for the U2794B:
 - The supply voltage and the control inputs GC, PC and PU are connected via a plug strip. The control input voltages can be generated via external potentiometers; then the inputs should be AC-grounded (time requirements in burst mode for power up have to be considered).
 - The outputs I, IX, Q, QX are DC coupled via an plug strip or can be AC-connected via SMB plugs for high frequency tests e.g. noise figure or s-parameter measurement. The Pins II, IIX, QQ, QQX allow user-definable filtering with 2 external capacitors CII, CQQ.
 - The offsets of both channels can be adjusted with two potentiometers or resistors.
 - The LO- and the RF-inputs are AC-coupled and connected via SMB plugs. If transmission line T3 is connected to the RF-input and AC-grounded at the other end, gain and noise performance can be improved (input matching to 50Ω).
 - The complementary RF-input is AC-coupled to GND (CRFX = 1 nF), the same appears to the complementary LO input (CNLO = 1 nF).
- A calibration part which allows to calibrate an s-parameter analyzer directly to the in- and output- signal ports of the U2794B.
- For single-ended measurements at the demodulator outputs, two OPs (e.g., AD620 or other) can be configured with programmable gain; together with an output-divider network RD = 450Ω to RL = 50Ω , direct measurements with 50Ω load impedances are possible at frequencies t < 100 kHz.

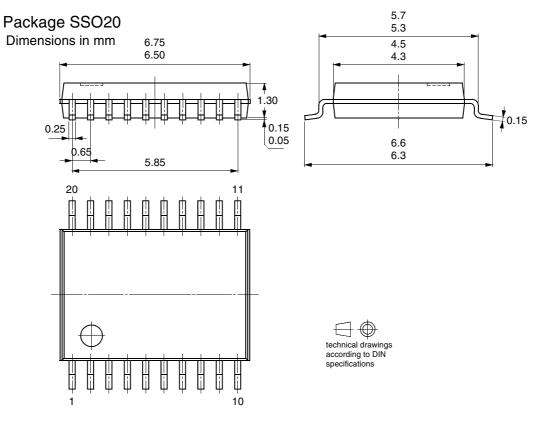




8. Ordering Information

| Extended Type Number | Package | Remarks |
|----------------------|---------|---|
| U2794B-NFSH | SSO20 | Tube, MOQ 830 pcs, Pb-free |
| U2794B-NFSG3H | SSO20 | Taped and reeled, MOQ 4000 pcs, Pb-free |

9. Package Information





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